Strain engineering of Schottky barriers in single and few-layer MoS₂ vertical devices.

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Two-dimensional transition metal dichalcogenides have demonstrated a huge potential for the development of novel electronic devices. Among them, atomically thin MoS₂ raises special interest due to its relatively high carrier mobility and intrinsic 1.8 eV bandgap [1, 2]. Further, it has been recently demonstrated that the band structure of atomically thin MoS₂ crystals can be modified applying uniaxial or biaxial strain [3], enhancing even more their technological possibilities.

In this work we study experimentally the electron transport through vertical metal/atomically thin MoS₂/metal junctions, using a conductive AFM tip to contact single and few-layer MoS₂ crystals deposited onto a metallic substrate. Remarkably, even when the MoS₂ crystal is just one layer thick, two metal-semiconductor barriers are formed at the tip/MoS₂ and MoS₂/substrate interfaces. As a consequence, the structure shows a strong rectifying I-V characteristic. Furthermore, the rectification ratio of the I-V characteristic can be modified by applying mechanical pressure to the MoS₂ crystal with the AFM tip.

To further demonstrate the studied devices, we use them to rectify a periodic voltage, controlling the rectification ratio through the mechanical pressure applied with the AFM tip.

References

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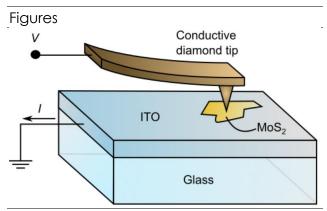


Figure 1: Schematic of the experimental setup: The semiconducting MoS₂ flake is sandwiched between a conductive ITO substrate and a metallic AFM tip. Two Schottky barriers are formed at the tip/MoS₂ and MoS₂/ITO interfaces.

